



August 1998

100325

Low Power Hex ECL-to-TTL Translator

General Description

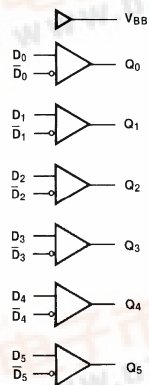
The 100325 is a hex translator for converting F100K logic levels to TTL logic levels. Differential inputs allow each circuit to be used as an inverting, non-inverting or differential receiver. An internal reference voltage generator provides V_{BB} for single-ended operation, or for use in Schmitt trigger applications. All inputs have 50 k Ω pull-down resistors. When the inputs are either unconnected or at the same potential the outputs will go low.

When used in single-ended operation the apparent input threshold of the true inputs is 20 mV to 40 mV higher (positive) than the threshold of the complementary inputs. The V_{EE} and V_{TTL} power may be applied in either order.

Features

- Pin/function compatible with 100125
- Meets 100125 AC specifications
- 50% power reduction of the 100125
- Differential inputs with built in offset
- Standard FAST[®] outputs
- 2000V ESD protection
- -4.2V to -5.7V operating range
- Available to Microcircuit Drawing (SMD) 5962-9153101

Logic Diagram

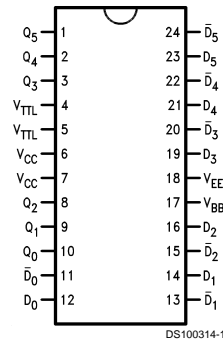


Pin Names	Description
D_0 – D_5	Data Inputs
\bar{D}_0 – \bar{D}_5	Inverting Data Inputs
Q_0 – Q_5	Data Outputs

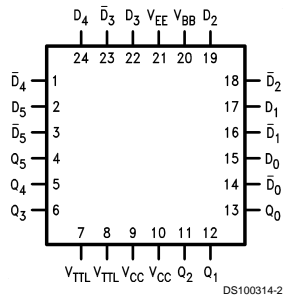
FAST[®] is a registered trademark of Fairchild Semiconductor.

Connection Diagrams

24-Pin DIP



24-Pin Quad Cerpak



Truth Table

Inputs		Outputs
D_n	\bar{D}_n	Q_n
L	H	L
H	L	H
L	L	L
H	H	L
Open	Open	L
V_{EE}	V_{EE}	L
L	V_{BB}	L
H	V_{BB}	H
V_{BB}	L	H
V_{BB}	H	L

H = HIGH Voltage Level
L = LOW Voltage Level

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Above which the useful life may be impaired.

Storage Temperature (T_{STG})	–65°C to +150°C
Maximum Junction Temperature (T_J)	
Ceramic	+175°C
V_{EE} Pin Potential to Ground Pin	–7.0V to +0.5V
V_{TTL} Pin Potential to Ground Pin	–0.5V to +6.0V
Input Voltage (DC)	V_{EE} to +0.5V

Voltage Applied to Output	
in HIGH State (with $V_{CC} = 0V$)	–0.5V to V_{CC}
Current Applied to Output	
in LOW State (Max)	twice the rated I_{OL} (mA)
ESD (Note 2)	≥2000V

Recommended Operating Conditions

Case Temperature (T_C)	
Military	–55°C to +125°C
Supply Voltage (V_{EE})	–5.7V to –4.2V

Note 1: Absolute maximum ratings are those values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: ESD testing conforms to MIL-STD-883, Method 3015.

Military Version

DC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = V_{CCA} = GND$, $T_C = -55^\circ C$ to $+125^\circ C$, $C_L = 50$ pF, $V_{TTL} = +4.5V$ to $+5.5V$

Symbol	Parameter	Min	Max	Units	T_C	Conditions	Notes
V_{BB}	Output Reference Voltage	–1380	–1260	mV	0°C to +125°C	$I_{V_{BB}} = -3 \mu A$, $V_{EE} = -4.2V$	(Notes 3, 4, 5)
						$I_{V_{BB}} = -2.1$ mA	
		–1396	–1260		–55°C	$I_{V_{BB}} = -3$ mA	
V_{IH}	Input HIGH Voltage	–1165	–870	mV	–55°C to +125°C	Guaranteed HIGH Signal for All Inputs (with One Input Tied to V_{BB})	(Notes 3, 4, 5, 6)
V_{IL}	Input LOW Voltage	–1830	–1475	mV	–55°C to +125°C	Guaranteed LOW Signal for All Inputs (with One Input Tied to V_{BB})	(Notes 3, 4, 5, 6)
V_{OH}	Output HIGH Voltage	2.5		mV	0°C to +125°C	$I_{OH} = -2.0$ mA	(Notes 3, 4, 5)
		2.4			–55°C	$V_{IN} = V_{IH} (Max)$ or $V_{IL} (Min)$	
V_{OL}	Output LOW Voltage		0.5	mV	–55°C to +125°C	$I_{OL} = 20$ mA	
V_{DIFF}	Input Voltage Differential	150		mV	–55°C to +125°C	Required for Full Output Swing	(Notes 3, 4, 5)
V_{CM}	Common Mode Voltage	–2000	–500	mV	–55°C to +125°C		(Notes 3, 4, 5, 6)
I_{IH}	Input HIGH Current		350	μA	0°C to +125°C	$V_{IN} = V_{IH} (Max)$, $D_0-D_5 = V_{BB}$, $\overline{D_0}-\overline{D_5} = V_{IL} (Min)$	(Notes 3, 4, 5)
			500		–55°C		
I_{IL}	Input LOW Current	0.50		μA	–55°C to +125°C	$V_{IN} = V_{IL} (Min)$, $D_0-D_5 = V_{BB}$	(Notes 3, 4, 5)
I_{OS}	Output Short Circuit Current	–150	–60	mA	–55°C to +125°C	$V_{OUT} = GND$ Test One Output at a Time	(Notes 3, 4, 5)
I_{CEX}	Output HIGH Leakage Current		250	μA	–55°C to +125°C	$V_{OUT} = 5.5V$	(Notes 3, 4, 5)
I_{EE}	V_{EE} Power Supply Current	–35	–12	mA	–55°C to +125°C	$D_0-D_5 = V_{BB}$	(Notes 3, 4, 5)
I_{TTL}	V_{TTL} Power Supply Current		65	mA	–55°C to +125°C	$D_0-D_5 = V_{BB}$	(Notes 3, 4, 5)

Note 3: F100K 300 Series cold temperature testing is performed by temperature soaking (to guarantee junction temperature equals –55°C), then testing immediately without allowing for the junction temperature to stabilize due to heat dissipation after power-up. This provides “cold start” specs which can be considered a worst case condition at cold temperatures.

Note 4: Screen tested 100% on each device at –55°C, +25°C, and +125°C, Subgroups 1, 2, 3, 7, and 8.

Note 5: Sample tested (Method 5005, Table I) on each manufactured lot at –55°C, +25°C, and +125°C, Subgroups A1, 2, 3, 7, and 8.

Note 6: Guaranteed by applying specified input condition and testing V_{OH}/V_{OL} .

AC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = GND$, $V_{TTL} = +4.5V$ to $+5.5V$

Symbol	Parameter	$T_C = -55^\circ C$		$T_C = +25^\circ C$		$T_C = +125^\circ C$		Units	Conditions	Notes
		Min	Max	Min	Max	Min	Max			
t_{PLH}	Propagation Delay	1.50	5.00	1.60	4.70	1.70	5.70	ns	$C_L = 50$ pF	(Notes 7, 8, 9)
t_{PHL}	Data to Output								Figures 1, 3	

Note 7: F100K 300 Series cold temperature testing is performed by temperature soaking (to guarantee junction temperature equals $-55^\circ C$), then testing immediately after power-up. This provides "cold start" specs which can be considered a worst case condition at cold temperatures.

Note 8: Screen tested 100% on each device at $+25^\circ C$, temperature only, Subgroup A9.

Note 9: Sample tested (Method 5005, Table I) on each manufactured lot at $+25^\circ C$, Subgroup A9, and at $+125^\circ C$ and $-55^\circ C$ temperatures, Subgroups A10 and A11.

Note 10: Not tested at $+25^\circ C$, $+125^\circ C$, and $-55^\circ C$ temperature (design characterization data).

Switching Waveform

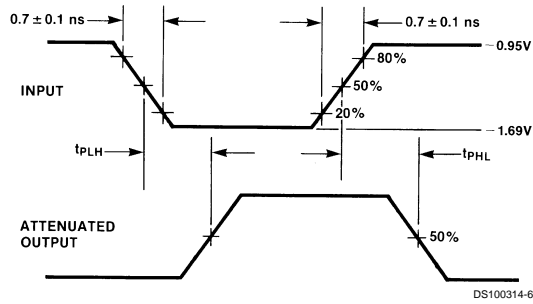
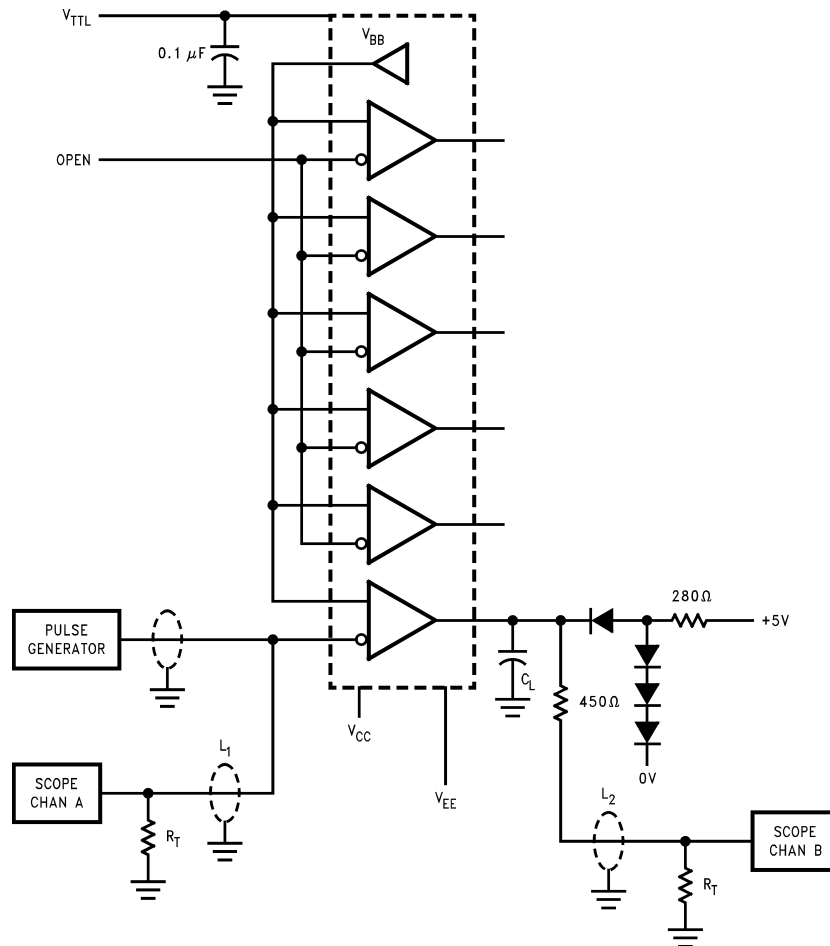


FIGURE 1. Propagation Delay

DS100314-6

Test Circuits



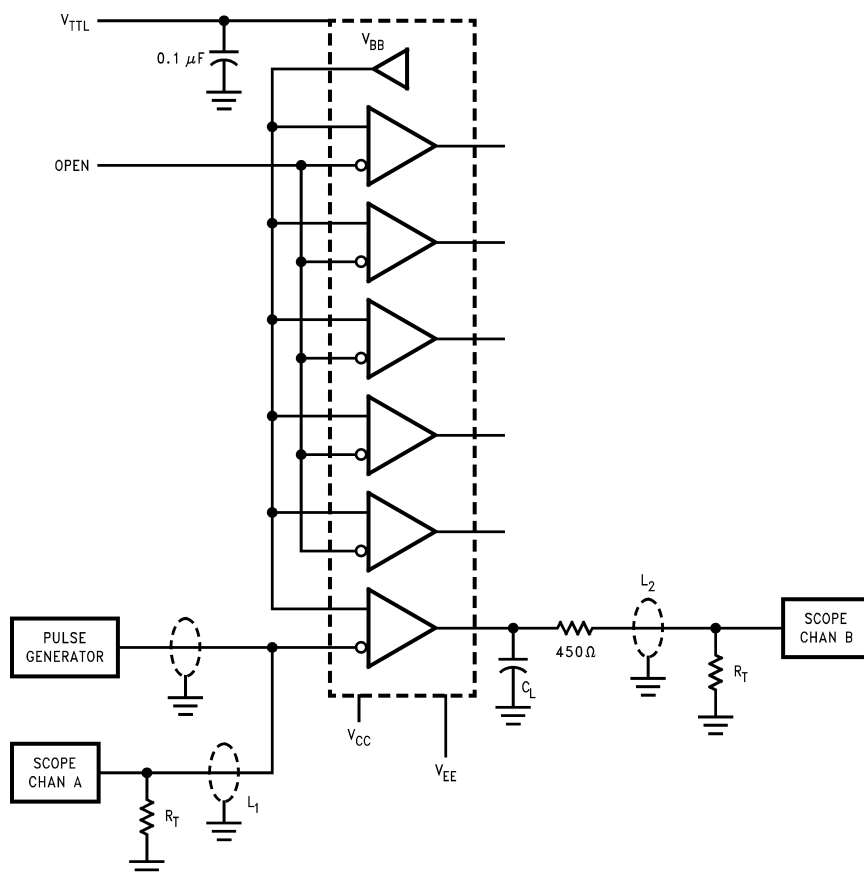
DS100314-5

Notes:

$V_{CC} = 0V$, $V_{EE} = -4.5V$, $V_{TTL} = +5V$
 $L1$ and $L2$ = equal length 50Ω impedance lines
 $R_T = 50\Omega$ terminator internal to scope
 Decoupling 0.1 μF from GND to V_{CC} , V_{EE} and V_{TTL}
 All unused outputs are loaded with 500Ω to GND
 C_L = Fixture and stray capacitance = 15 pF

FIGURE 2. AC Test Circuit for 15 pF Loading

Test Circuits (Continued)



DS100314-8

Notes:

$V_{CC} = 0V$, $V_{EE} = -4.5V$, $V_{TTL} = +5V$

$L1$ and $L2$ = equal length 50Ω impedance lines

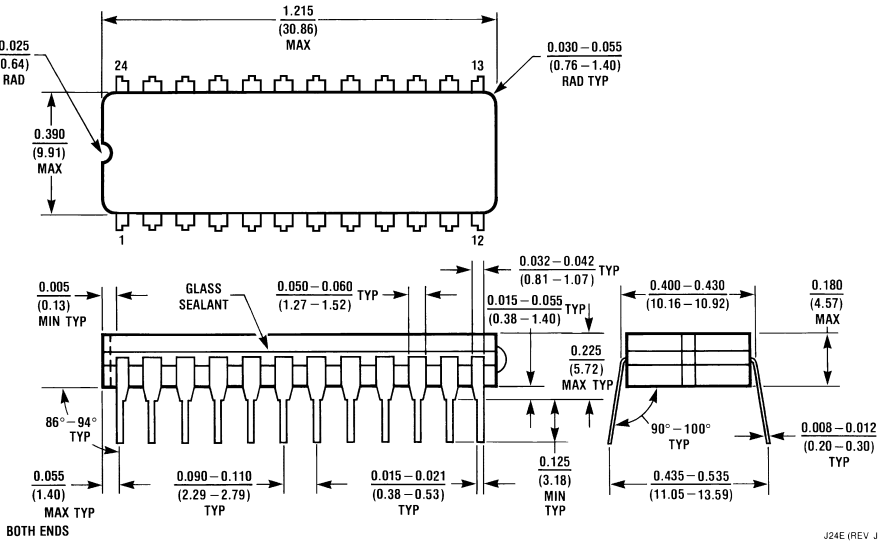
$R_T = 50\Omega$ terminator internal to scope

Decoupling $0.1 \mu F$ from GND to V_{CC} , V_{EE} and V_{TTL}

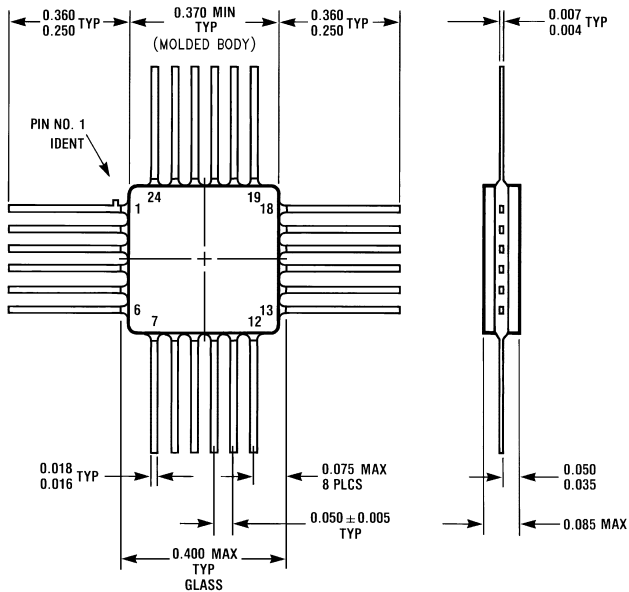
All unused outputs are loaded with 500Ω to GND

C_L = Fixture and stray capacitance = 50 pF

FIGURE 3. AC Test Circuit for 50 pF Loading

Physical Dimensions inches (millimeters) unless otherwise noted

24 Lead Ceramic Dual-In-Line Package (0.400" Wide) (D)
NS Package Number J24E



24 Lead Quad Cerpak (F)
NS Package Number W24B

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